## Specification for Approval

DEVICE NUMBER: BL-S3158D

SAMPLES ATTACHED AREA

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2013/4/30	1.0	1.0	1.0	1.0				Original Released
2014/9/5	1.1	1.1	1.1	1.1				Up Date
2016/1/13	1.2	1.2	1.2	1.2				New Version
								#
						*		

#### FOR CUSTOMER'S APPROVAL STAMP OR SIGNATURE

APPROVED	PURCHASE	MANUFACTURE	QUALITY	ENGINEERING

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ISSUED	APPROVED	PREPARED	
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2016.01.13	2016.01.13	2016.01.13	
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**BL-S3158D** 

#### Features:

1. Chip material: GaAsP/GaP

2. Emitted color: Yellow

3. Lens Appearance: Yellow Diffused

4. General purpose leads.

5. Low power consumption.

6. Compatible/ low current requirements

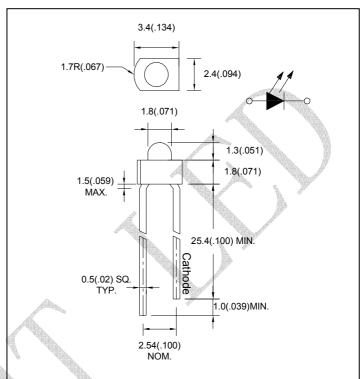
7. Reliable and rugged.

8. This product don't contained restriction substance, compliance RoHS standard.

### Applications:

- 1. TV set
- 2. Monitor
- 3. Telephone
- 4. Computer
- 5. Circuit board

#### Package dimensions:



#### Notes:

- 1. All dimensions are in millimeters (inches).
- 2. Tolerance is ±0.25mm (0.01") unless otherwise specified.
- 3. Lead spacing is measured where the leads emerge from the package.
- 4. Specifications are subject to change without notice.

### ● Absolute Maximum Ratings(Ta=25°C)

Parameter	Symbol	Rating	Unit
Power Dissipation	Pd	80	mW
Forward Current	I <sub>F</sub>	30	mA
Peak Forward Current*1	I <sub>FP</sub>	150	mA
Reverse Voltage	V <sub>R</sub>	5	V
Operating Temperature	Topr	-40℃~85℃	
Storage Temperature	Tstg	-40℃~85℃	

<sup>\*</sup>¹Condition for I<sub>FP</sub> is pulse of 1/10 duty and 0.1 msec width.



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■ Electrical and optical characteristics(Ta=25°C)

Parameter	Symbol	Condition	Min.	Тур.	Max.	Unit
Forward Voltage	VF	IF=20mA	-	2.1	2.6	V
Luminous Intensity	lv	IF=20mA	-	30	-	mcd
Reverse Current	IR	VR=5V	-	-	100	μA
Peak Wave Length	λp	IF=20mA	-	585	-	nm
Dominant Wave Length	λd	IF=20mA	580	-	595	nm
Spectral Line Half-width	Δλ	IF=20mA	-	35	<u>-</u>	nm
Viewing Angle	201/2	IF=20mA	-	55	<u>-</u>	deg

### Typical Electro-Optical Characteristics Curves

Fig.1 Relative intensity vs. Wavelength

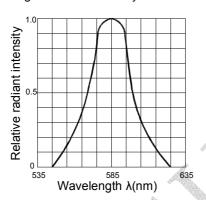


Fig.3 Forward current vs. Forward voltage

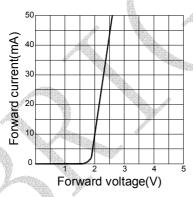


Fig.5 Relative luminous intensity

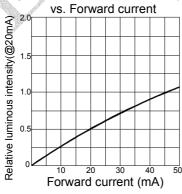


Fig.2 Forward current derating curve

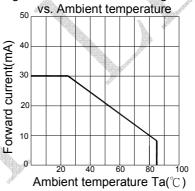


Fig.4 Relative luminous intensity

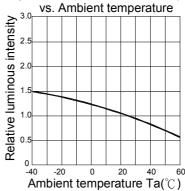
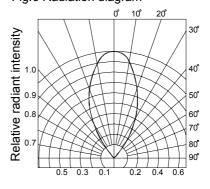


Fig.6 Radiation diagram





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### Reliability Test

Classification	Test Item	Reference Standard	Test Conditions	Result
	Operation Life	MIL-STD-750:1026 MIL-STD-883:1005 JIS-C-7021 :B-1	I <sub>F</sub> =20mA Ta=+25°ℂ±5°ℂ Test time=1,000hrs	0/32
Endurance Test	High Temperature High Humidity Storage	MIL-STD-202:103B JIS-C-7021 :B-11	Ta=+85°C±5°C RH=90%-95% Test time=240hrs	0/32
	High Temperature Storage	MIL-STD-883:1008 JIS-C-7021 :B-10	High Ta=+85°C±5°C Test time=1,000hrs	0/32
	Low Temperature Storage	JIS-C-7021 :B-12	Low Ta=-45°C±5°C Test time=1,000hrs	0/32
	Temperature Cycling	MIL-STD-202:107D MIL-STD-750:1051 MIL-STD-883:1010 JIS-C-7021 :A-4	Ta: $+85^{\circ}$ C(30min) ~ $+25^{\circ}$ C(5min) ~ $-45^{\circ}$ C(30min) ~ $+25^{\circ}$ C(5min)  Test Time : 70min/ctcle 10cycle	0/32
Environmental	Thermal Shock	MIL-STD-202:107D MIL-STD-750:1051 MIL-STD-883:1011	-45°C±5°C ~+85°C±5°C 20min 20min Test Time=10cycle	0/32
Test	Solder Resistance	MIL-STD-202:201A MIL-STD-750:2031 JIS-C-7021 :A-1	Preheating : 120℃,within 120-180 sec. Operation heating : 255℃±5℃ within 5 sec.260℃ (Max)	0/32
	Solderability	MIL-STD-202F:208D MIL-STD-750D:2026 MIL-STD-883D:2003 JIS C 7021:A-2	T.sol=230±5°C Dwell Time=5±1secs	0/32

### Judgment criteria of failure for the reliability

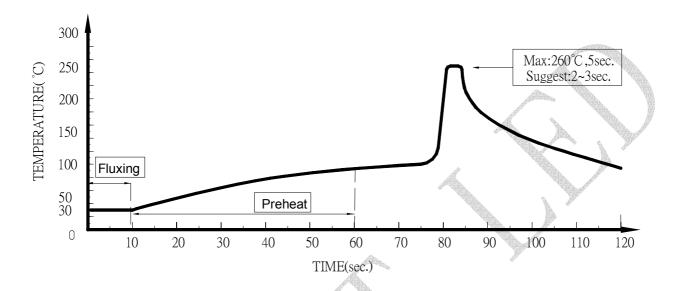
Measuring items	Symbol	Measuring conditions	Judgment criteria for failure
Forward voltage	V <sub>F</sub> (V)	I <sub>F</sub> =20mA	Over U <sup>1</sup> x1.2
Reverse current	I <sub>R</sub> (uA)	V <sub>R</sub> =5V	Over U <sup>1</sup> x2
Luminous intensity	lv ( mcd)	I <sub>F</sub> =20mA	Below S <sup>1</sup> X0.5

Note: 1. U means the upper limit of specified characteristics. S means initial value.

2. Measurment shall be taken between 2 hours and after the test pieces have been returned to normal ambient conditions after completion of each test.

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### Dip Soldering



- 1. Please avoid any external stress applied to the lead-frames and epoxy while the LEDs are at high temperature, especially during soldering
- 2. DIP soldering and hand soldering should not be done more than one time.
- 3. After soldering, avoid the epoxy lens from mechanical shock or vibration until the LEDs are back to room temerature.
- 4. Avoid rapid cooling during temperature ramp-down process
- 5. Although the soldering condition is recommended above, soldering at the lowest possible temperature is feasible for the LEDs

### ● IRON Soldering

300℃ Within 3 sec.,One time only.